

S21MD10V

■ Features

1. Built-in zero-cross circuit
2. High critical rate of rise of OFF-state voltage
(dV/dt :MIN. 1 000V/ μ s)
3. High repetitive peak OFF-state voltage (V_{DRM} :MIN. 600V)
4. Isolation voltage between input and output
(V_{iso} (rms):5kV)
5. Recognized by UL, file No.E64380
 - * DIN-VDE 0884 approved type is also available as an option
Approved by VDE, No.104842
 - * **S21MD10V** is for 200V line

■ Applications

1. For triggering medium/high power triac

■ Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit	
Input	Forward current	I_F	50	mA
	Reverse voltage	V_R	6	V
Output	RMS ON-state current	I_T (rms)	0.1	A
	*1 Peak one cycle surge current	I_{surge}	1.2	A
	Repetitive peak OFF-state voltage	V_{DRM}	600	V
*2 Isolation voltage	V_{iso} (rms)	5	kV	
Operating temperature	T_{opr}	-30 to +100	°C	
Storage temperature	T_{stg}	-55 to +125	°C	
*3 Soldering temperature	T_{sol}	260	°C	

*1 50Hz Sine wave

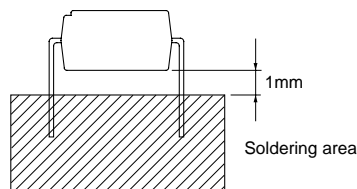
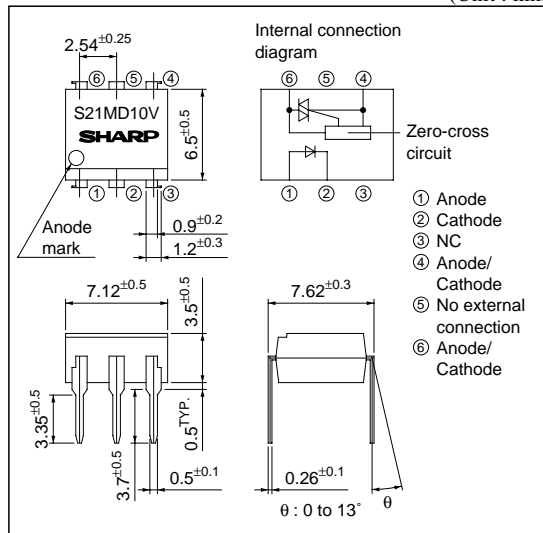
*2 40 to 60% RH, AC for 1 min, f=60HZ

*3 For 10s

Built-in Zero-cross Circuit, High Noise Resistance Type Phototriac Coupler

■ Outline Dimensions

(Unit : mm)



■ Electro-optical Characteristics

($T_a=25^\circ\text{C}$)

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Input	Forward voltage	V_F	$I_F=20\text{mA}$	—	1.2	1.4	V
	Reverse current	I_R	$V_R=3\text{V}$	—	—	10^{-5}	A
Output	Repetitive peak OFF-state current	I_{DRM}	$V_{DRM}=\text{Rated}$	—	—	10^{-6}	A
	On-state voltage	V_T	$I_T=100\text{mA}$	—	—	3.0	V
	Holding current	I_H	$V_D=6\text{V}$	0.1	—	3.5	mA
	Critical rate of rise of OFF-state voltage	dV/dt	$V_{DRM}=1/\sqrt{2}$ Rated	1 000	2 000	—	V/ μs
	Zero-cross voltage	V_{OX}	Resistance load, $I_F=10\text{mA}$	—	—	20	V
Transfer characteristics	Minimum trigger current	I_{FT}	$V_D=6\text{V}$, $R_L=100\Omega$	—	—	5	mA
	Isolation resistance	R_{ISO}	DC500V, 40 to 60%RH	5×10^{10}	1×10^{11}	—	Ω
	Turn-on time	t_{on}	$V_D=6\text{V}$, $R_L=100\Omega$, $I_F=20\text{mA}$	—	—	35	μs

Fig.1 RMS ON-state Current vs. Ambient Temperature

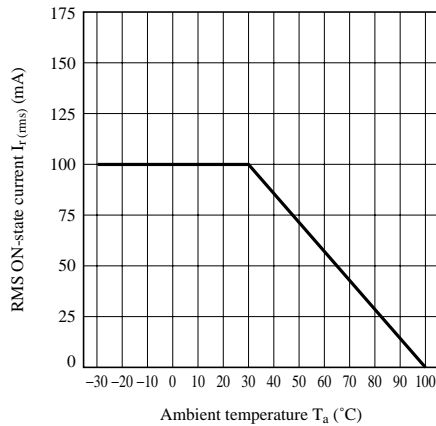


Fig.2 Forward Current vs. Ambient Temperature

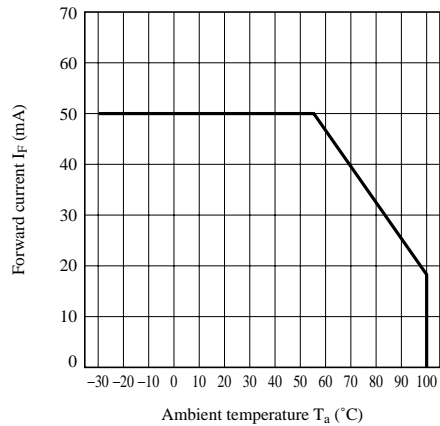


Fig.3 Forward Current vs. Forward Voltage

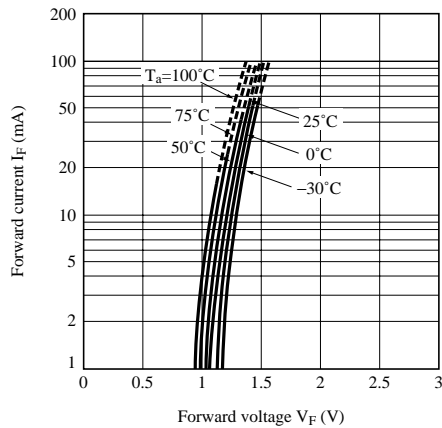


Fig.4 Minimum Trigger Current vs. Ambient Temperature

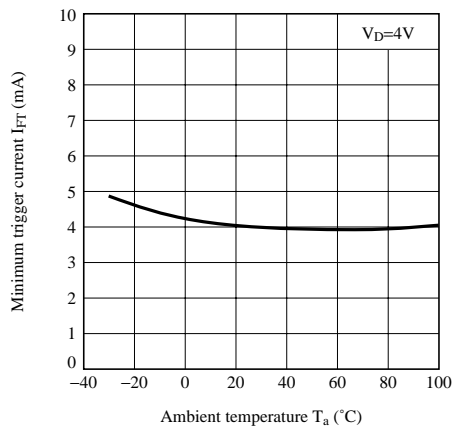


Fig.5 ON-state Voltage vs. Ambient Temperature

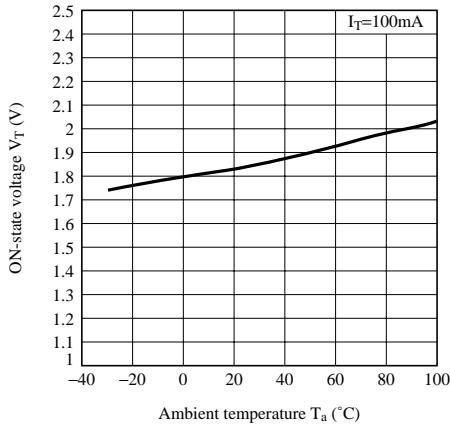


Fig.6 Holding Current vs. Ambient Temperature

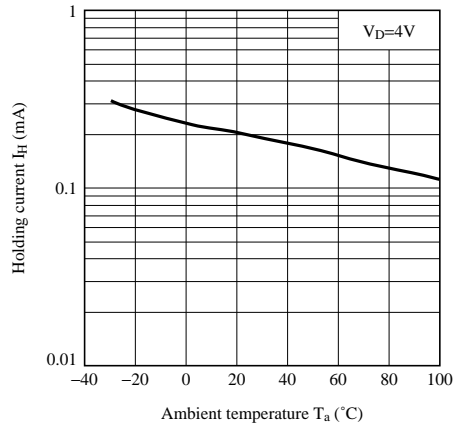


Fig.7 Repetitive Peak OFF-state Current vs. Ambient Temperature

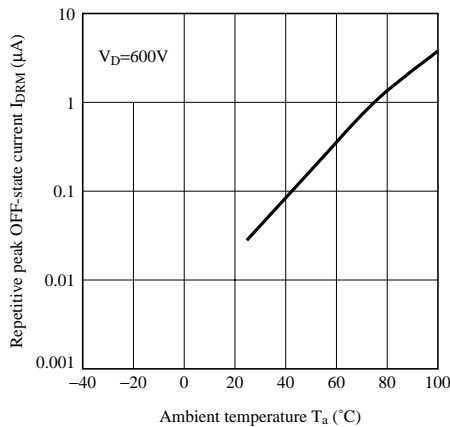


Fig.8 Relative Repetitive Peak OFF-state Voltage vs. Ambient Temperature

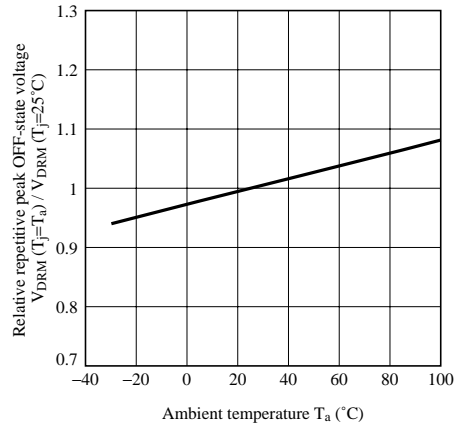


Fig.9 Turn-on Time vs. Forward Current

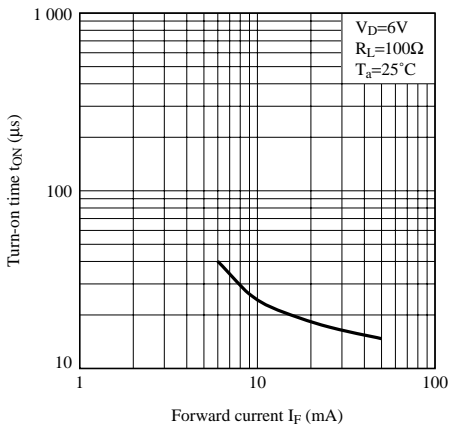


Fig.10 Zero-cross Voltage vs. Ambient Temperature

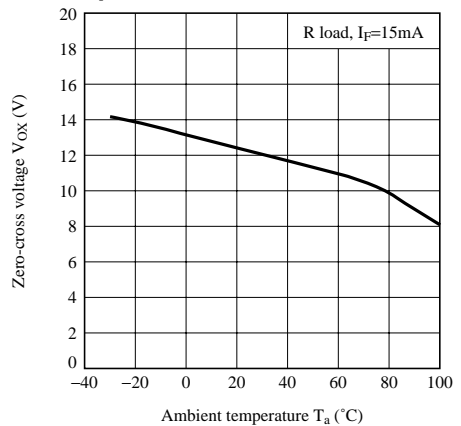
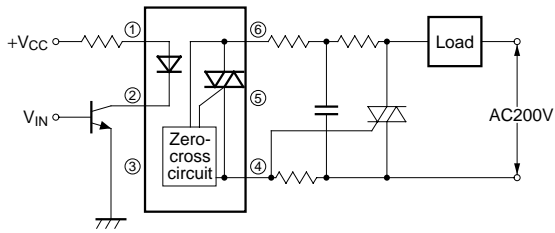


Fig.11 Basic Operation Circuit

Medium/High Power Triac Drive Circuit



Note) Please use on condition of the triac for power triggers.

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